

PIN HEADER 2.54

Pin Header 2.54mm 2 Row H=2.5mm SMT R/A Type



Specifications

Current Rate: 3 AMP | Insulation Resistance: 1000MΩ | Min. Contact Resistance: 20mΩ |
Max. Dielectric Voltage: 1000V AC for one minute | Operation Temperature: -40°C to +105°C

Material

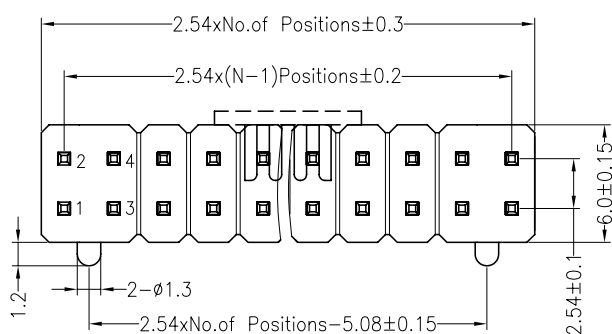
Insulator: Hi-Temp. Thermoplastic, UL 94V-0 | Terminal: Copper Alloy | Plating: Gold Plated



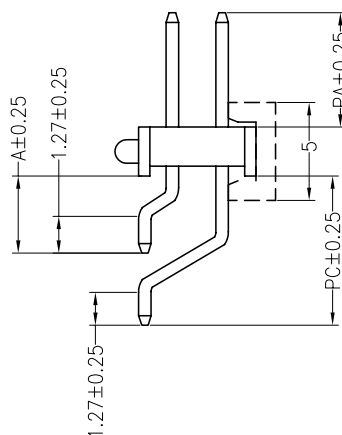
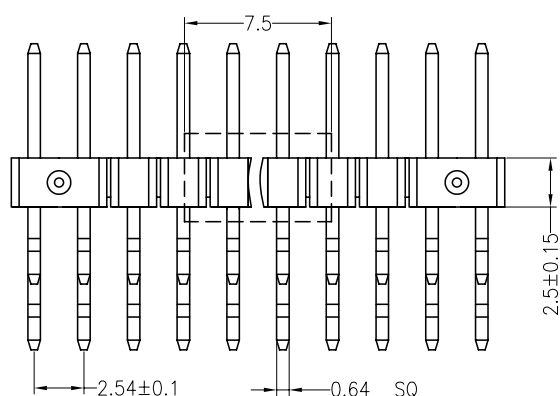
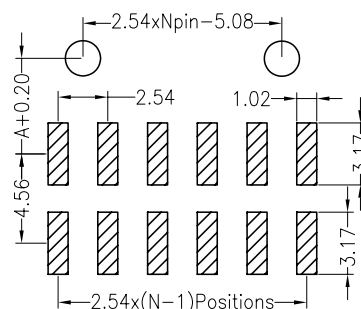
With - Positioning Peg (Post)

ORDER INFORMATION

P	H	1	M	R	2	5	-	2	X	X	X	W	X	X	Z	PA/PC/A	X	
									No. of Pins Pr Row		Insulator Material Option		Contact Plating			PA/ PC/A= Pin Lenght		Packing
									2x40		A=BK-PBT B=BK-PA66 C=BK-PA6T D=BKPA46 F=BK-LCP		G0= Gold Flash G2= 5U" Gold G3= 10U" Gold G4= 15U" Gold G5= 30U" Gold S0= Gold Flash/Tin SN= Tin					0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap



Recommended P.C.B Layout (Top Side)
(PCB BOARD TOLERANCE ±0.05)



ITEM	PA	PC	A
Standard	6.00	XX	XX
Alternate			

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TOPTTEK®
HARDWARE ELECTRONIC COMPONENTS



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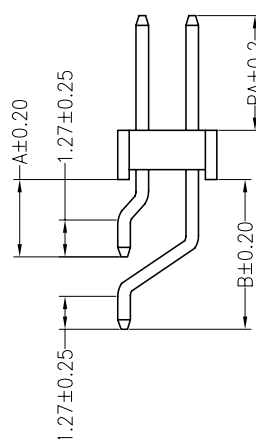
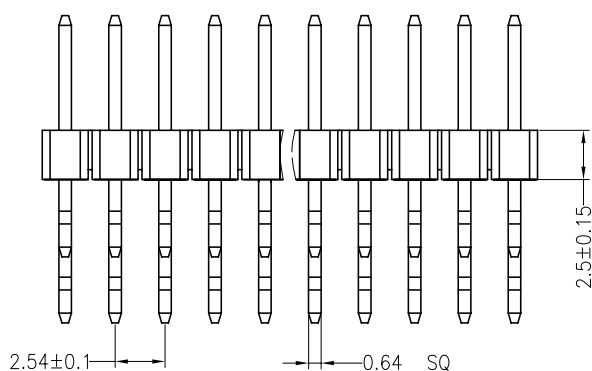
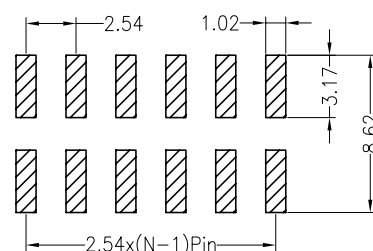
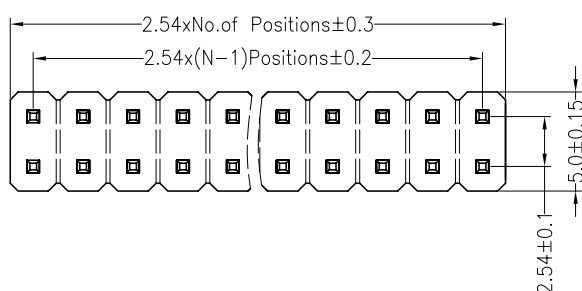


Without - Positioning Peg (Post)

ORDER INFORMATION

P	H	1	M	R	2	5	-	2	X	X	X	X	X	Z	PA/A/B	X	
									No.of Pins Pr Row		Insulator Material Option		Contact Plating		PA/ A/ B= Pin Lenght		Packing
									2x40		A= BK-PBT B=BK-PA66 C=BK-PA6T D=BKPA46 F=BK-LCP		G0= Gold Flash G2= 5U" Gold G3= 10U" Gold G4= 15U" Gold G5= 30U" Gold S0= Gold Flash/Tin SN= Tin				0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap

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